

## DESCRIPTION

## Polyether Composition

## TECHNICAL FIELD

The present invention relates to a polyether composition containing polyether having a relatively low glass transition temperature and melting point.

## BACKGROUND ART

Previously, polyether has been widely used in various utilities, and since, particular, polyether having a low glass transition temperature and melting point has an advantage that it can be molded at a low temperature, and exerts excellent adherability, it is known that it is suitable in utilities such as an extrusion molding material, an antistatic agent, a polymer electrolyte, and a protecting membrane for a color filter.

However, polyether has a defect that it is easily oxidized and degraded due to its structure and, previously, when used in the aforementioned various utilities, a molecular weight is reduced in steps of storage, transport, molding, film forming, and the like, depending on the condition, in some cases. When a molecular weight is reduced like this, a problem such as difficulty in molding and film forming, reduction in physical properties such as a mechanical strength, and production of a smell substance and a toxic substance arises. For this reason, when polyether is handled in steps of storage, transport, molding, film forming, and the like, it is necessary to take a measure so as not to reduce a molecular weight, or performance at a relatively low temperature, or under the inert gas atmosphere.

However, in polyether having a relatively low glass transition temperature and melting point, specifically, polyether having a glass transition temperature of  $-50^{\circ}\text{C}$  or

lower, and a melting point of 55°C or lower, in the existing circumstances, reduction in a molecular weight occurs very easily, and reduction in a molecular weight can not be sufficiently suppressed only by taking the aforementioned measure so as not to reduce a molecular weight.

## DISCLOSURE OF THE INVENTION

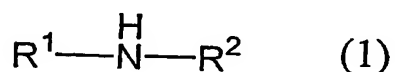
### OBJECT OF THE INVENTION

Then, an object of the present invention is to provide a polyether composition which can suppress reduction in a molecular weight of polyether having a low glass transition temperature and melting point.

### SUMMARY OF THE INVENTION

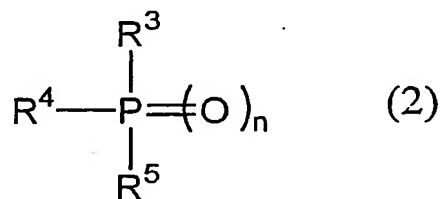
In order to solve the aforementioned problems, the present inventors intensively studied. As a result, a specified compound which can effectively suppress reduction in a molecular weight of polyol having a glass transition temperature of -50°C or lower and a melting point of 55°C or lower by incorporating into the polymer was found out. The present invention was completed based on this finding.

That is, the polyether composition of the present invention contains polyether having a glass transition temperature of -50°C or lower, and a melting point of 55°C or lower and, at the same time, also contains at least one kind selected from the group consisting of a compound represented by the following general formula (1), a compound represented by the following general formula (2) and a compound represented by the following general formula (3).

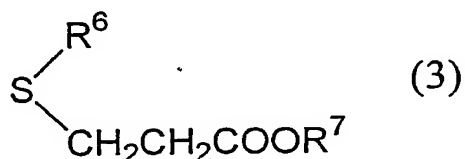


(in the formula (1), R<sup>1</sup> and R<sup>2</sup> are each independently an alkyl group of a carbon number

of 1 to 8, an alkenyl group, an aryl group, an alkoxyl group, or a substituted aryl group, or R<sup>1</sup> and R<sup>2</sup> may be bound to each other directly or via at least one kind element selected from C, O, S, P and N)



(in the formula (2), R<sup>3</sup>, R<sup>4</sup> and R<sup>5</sup> are each independently an alkyl group of a carbon number of 1 to 8, an alkenyl group, an aryl group, an alkoxyl group, a substituted aryl group, or an amino group, or R<sup>3</sup> and R<sup>4</sup> may be bound to each other directly or via at least one kind element selected from C, O, S, P and N, and n is 0 or 1)



(in the formula (3), R<sup>6</sup> is an organic residue, and R<sup>7</sup> is an alkyl group of a carbon number of 1 to 30)

### EFFECTS OF THE INVENTION

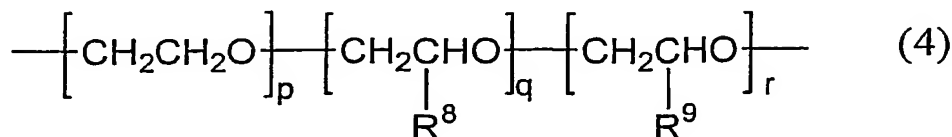
The polyether composition of the present invention can effectively suppress reduction in a molecular weight of even polyether having a low glass transition temperature and melting point, and can avoid a problem such as difficulty in molding or film forming, reduction in physical properties such as a melting point and a mechanical strength, and production of a smell substance and a toxic substance.

### DETAILED DESCRIPTION OF THE INVENTION

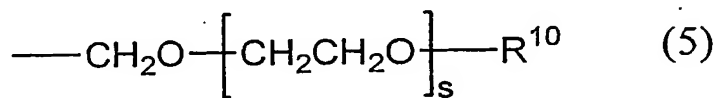
The polyether composition of the present invention will be explained in detail below, but a scope of the present invention is not restricted by the explanation, and alternation can be appropriately practiced in such the range that the gist of the present invention is not deteriorated, also regarding aspects other than the following embodiments.

The polyether composition of the present invention contains, as a main component, polyether having a glass transition temperature of  $-50^{\circ}\text{C}$  or lower, and a melting point of  $55^{\circ}\text{C}$  or lower. By a glass transition temperature of the polyether of  $-50^{\circ}\text{C}$  or lower, and a melting point of the polyether of  $55^{\circ}\text{C}$  or lower, a composition having an advantage that molding at a low temperature becomes possible, and excellent adherability is exerted, is obtained. Further, for example, when the polyether composition of the present invention is used by formulating into a film, there is also an advantage that a film having better shape retaining force, flexibility, toughness and strength at its use temperature region can be obtained. A lower limit of a glass transition temperature and a melting point of the polyether is not particularly limited, but in particular a melting point is preferably  $30^{\circ}\text{C}$  or higher, more preferably  $35^{\circ}\text{C}$  or higher. When a melting point of the polyether is lower than  $30^{\circ}\text{C}$ , in the case where the polyether composition of the present invention is used by formulating into a film, there is a tendency that a film shape is retained with difficulty in its use temperature region. The glass transition temperature and the melting point in the present invention can be measured using a differential thermal analyzer, specifically, by rapidly heating a polymer from which volatile matters have been removed if necessary, to  $80^{\circ}\text{C}$  and what has been moisture-conditioned to be melt once, cooling the polymer from  $80^{\circ}\text{C}$  to  $-100^{\circ}\text{C}$  at  $5^{\circ}\text{C}/\text{min}$  to crystallize it, and elevating a temperature of the crystallized polymer from  $-100^{\circ}\text{C}$  to  $80^{\circ}\text{C}$  at  $5^{\circ}\text{C}/\text{min}$ .

Preferably examples of the polyether include a polymer having a constitutional unit represented by the following general formula (4).



(in the formula (4),  $\text{R}^8$  and  $\text{R}^9$  are each independently an alkyl group of a carbon number of 1 to 8, an alkenyl group, an aryl group, an alkoxyl group, a substituted aryl group, or a group represented by the following general formula (5), all of  $p$ ,  $q$  and  $r$  are an integer of 0 or larger, and  $p+q+r > 0$ )



(in the formula (5),  $\text{R}^{10}$  is an alkyl group of a carbon number of 1 to 8, an alkenyl group, an aryl group, an alkoxyl group, or a substituted aryl group, and  $s$  is an integer of 0 or larger)

In the general formulas (4) and (5), specific examples of the alkyl group represented by  $\text{R}^8$ ,  $\text{R}^9$  and  $\text{R}^{10}$  include a methyl group, an ethyl group, a propyl group, and a butyl group, specific examples of the alkenyl group include an allyl group, and a vinyl group, specific examples of the aryl group include a phenyl group, and a diphenyl group, specific examples of the alkoxyl group include a methoxy group, an ethoxy group, and a butoxy group, and specific examples of the substituted aryl group include a methylphenyl group, and an ethylphenyl group.

Specific examples of the polymer having a constitutional unit represented by the general formula (4) include polyethylene oxide, polypropylene oxide, polybutylene

oxide, polyallyl glycidyl ether, polymethoxyethyl glycidyl ether, and a copolymer of monomers constituting these polymers (e.g. ethylene oxide/propylene oxide copolymer). The polyether may be one kind, or two or more kinds.

The polyether has an elongation viscosity under a shear rate of 100 to 500 (1/sec) of preferably 100 to 1,000,000Pa·s, more preferably 500 to 500,000Pa·s, further preferably 1,000 to 100,000Pa·s. When the elongation viscosity is less than 100Pa·s, there is a tendency that a strength when formulated into a film becomes insufficient. For example, when the polyether composition of the present invention is used by formulating into a film, since a tension of a film at melting becomes low upon molding into a film, there is a possibility that the film is cut at melting. On the other hand, when the elongation viscosity exceeds 1,000,000Pa·s, there is a tendency that moldability is deteriorated. For example, when the polyether composition of the present invention is used by formulating into a film, since a torque becomes high upon extrusion into a film, and extrusion may become difficult, both cases are not preferable. By both of its melting point and elongation viscosity satisfying the aforementioned ranges, when the polyether composition of the present invention is used by formulating, for example, into a film, the polyether can combine a tension of a film at melting with a torque upon extrusion when molded into a film. And, a film better in shape retaining force, flexibility, toughness and strength at its use temperature region can be easily obtain. The elongation viscosity in the present invention is measured at a temperature of 100 to 110°C under a resin solid matter of 100%, and measurement of the elongation viscosity can be specifically performed, for example, under the following conditions.

Measuring equipment: Twin Capillary Rheometer ("RH7-2 type" manufactured by Rossant)

Die: a long die (length 32mm) · short die (length 0.25mm) having a diameter of

2mm

Die angle: 180°

Retention time: 10min

Atmosphere: dry air

Polymer pretreatment: a polymer is allowed to stand in a glove box at room temperature for 24 hours under the nitrogen atmosphere.

A weight average molecular weight ( $M_w$ ) of the polyether may be appropriately set depending on utilities, is not particularly limited, but is preferably 10,000 to 1,500,000. When a weight average molecular weight is less than 10,000, there is a possibility that tack is produced upon molding and film forming, and handling property is deteriorated. On the other hand, when a weight average molecular weight exceeds 1,500,000, there is a possibility that molding or film forming themselves become difficult, and processibility is reduced.

A molecular weight distribution ( $M_w/M_n$ ) of the polyether may be approximately set depending on utilities, is not particularly limited, but is preferably 5 or smaller. When a molecular weight distribution exceeds 5, there is a possibility that tack occurs upon molding or film forming, and handling property is deteriorated.

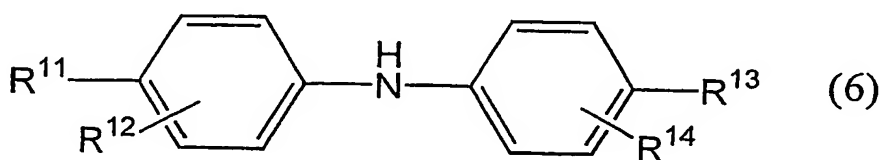
The polyether composition of the present invention also contains at least one kind selected from the group consisting of a compound represented by the general formula (1), a compound represented by the general formula (2) and a compound represented by the general formula (3) (hereinafter, referred to as "specified compound X" in some cases). Thereby, in the case of even the aforementioned polyether having a low glass transition temperature and melting point, reduction in its molecular weight can be effectively suppressed. The specified compound X may be any kind of a compound represented by the general formula (1), a compound represented by the

general formula (2), and a compound represented by the general formula (3), and preferable is two or more kinds.

In the general formula (1), specific examples of the alkyl group represented by  $R^1$  and  $R^2$  include a methyl group, an ethyl group, a butyl group, a hexyl group, and an octyl group, specific examples of the alkenyl group include allyl group, a vinyl group, an ethenyl group, and a butenyl group, specific examples of the aryl group include a phenyl group, a diphenyl group, and a naphthyl group, specific examples of the alkoxy group include a methoxy group, an ethoxy group, and a methoxyethyl group, and specific examples of the substituted aryl group include a methylphenyl group, and a methoxyphenyl group.

Specific examples of the compound represented by the general formula (1) include diphenylamines, dinaphthylamines, diphenylphenylenediamines, and phenothiazines. These may be only one kind, or two or more kinds.

As the compound represented by the general formula (1), in particular, diphenylamines represented by the general formula (6) are preferable.



(in the formula (6),  $R^{11}$ ,  $R^{12}$ ,  $R^{13}$  and  $R^{14}$  are each independently a hydrogen atom or a hydrocarbon group of a carbon number of 1 to 18)

In the general formula (6), examples of the hydrocarbon group represented by  $R^{11}$ ,  $R^{12}$ ,  $R^{13}$  and  $R^{14}$  include a straight or branched alkyl group of a carbon number of 1 to 18, a straight or branched alkenyl group of a carbon number of 2 to 18, a cycloalkyl group of a carbon number of 6 to 18, and an aryl group of a carbon number of 6 to 18,



and an aryl group may contain an alkyl group or an alkenyl group having a carbon number of 1 to 12. Inter alia, an alkyl group such as a methyl group, an ethyl group, a propyl group, a butyl group, a tertiary butyl group, a pentyl group, a hexyl group, a heptyl group, an octyl group, a nonyl group, a decyl group, an undecyl group, a dodecyl group, a tridecyl group, a tetradecyl group, a pentadecyl group, a hexadecyl group, a heptadecyl group, an octadecyl group, and an isomer thereof is preferable, and an alkyl group of a carbon number of 3 to 10 is particularly preferable.

Specific examples of diphenylamines represented by the general formula (6) include diphenylamine, p,p'-dibutyldiphenylamine, p,p'-di-tertiary butyldiphenylamine, p,p'-dipentyldiphenylamine, p,p'-dihexyldiphenylamine, p,p'-diheptyldiphenylamine, p,p'-dioctyldiphenylamine, p,p'-dinonyldiphenylamine, monooctyldiphenylamine, monononyldiphenylamine, tetrabutyl diphenylamine, tetrahexyldiphenylamine, tetraoctyldiphenylamine, tetranonyldiphenylamine, mixed alkyldiphenylamine of a carbon number of 4 to 9, N-phenyl-1-naphthylamine, N-phenyl-2-naphthylamine, 4-n-butylaminophenol, 4-butyrylamino phenol, 4-nonanoylamino phenol, 4-dodecanoylamino phenol, 4-octadecanoylamino phenol, di(4-methoxyphenyl)amine, 2,6-di-tertiary-butyl-4-dimethylaminomethylphenol, 2,4'-diaminodiphenylmethane, 4,4'-diaminodiphenylmethane, N,N,N',N'-tetramethyl-4,4'-diaminodiphenylmethane, 1,2-di[(2-methylphenyl)amino]ethane, 1,2-di(phenylamino)propane, (o-tolyl) niguamide, di[4-(1',3'-dimethylbutyl)phenyl]amine, tertiary octylated N-phenyl-1-naphthylamine, and styrenated diphenylamine. Among them, in particular, phenothiazine, 10-methylphenothiazine, 2-methylphenothiazine, 2-trifluoromethylphenothiazine, and phenozadine are more preferable.

In the general formula (2), specific examples of the alkyl group represented by  $R^3$ ,  $R^4$  and  $R^5$  include a methyl group, an ethyl group, a propyl group, and a butyl group,

specific examples of the alkenyl group include an allyl group, a vinyl group, an ethenyl group, and a butenyl group, specific examples of the aryl group include a phenyl group, a diphenyl group, and a naphthyl group, specific examples of the alkoxyl group include a methoxy group, an ethoxy group, a phenoxy group, and a substituted phenoxy group, specific examples of the substituted aryl group include a methylphenyl group, and a methoxyphenyl group, and specific examples of the amino group include a methylamino group and a dimethylamino group.

Specific examples of the compound represented by the general formula (2) include triphenyl phosphite, tris(2,4-di-tertiary butylphenyl) phosphite, tris(2,5-di-tertiary butylphenyl) phosphite, tris(nonylphenyl) phosphite, tris(dinonylphenyl) phosphite, tris(mono-di-mixed nonylphenyl) phosphite, diphenylacid phosphite, 2,2'-methylenebis(4,6-di-tertiary butylphenyl)octyl phosphite, diphenyldecyl phosphite, diphenyloctyl phosphite, di(nonylphenyl)pentaerythritol diphosphite, phenyldiisodecyl phosphite, tributyl phosphite, tris(2-ethylhexyl) phosphite, tridecyl phosphite, trilauryl phosphite, dibutylacid phosphite, dilaurylacid phosphite, trilauryl trithiophosphite, bis(neopentyl glycol)-1,4-cyclohexanedimethyl diphosphite, bis(2,4-di-tertiary butylphenyl)pentaerythritol diphosphite, bis(2,5-di-tertiary butylphenyl)pentaerythritol diphosphite, bis(2,6-di-tertiary butyl-4-methylphenyl)pentaerythritol diphosphite, bis(2,4-dicumylphenyl)pentaerythritol diphosphite, distearyl pentaerythritol diphosphite, tetra(C12 to 15 mixed alkyl)-4,4'-isopropylidenediphenyl phosphite, bis[2,2'-methylenebis(4,6-diaminophenyl)]isopropylidenediphenyl phosphite, tetratridecyl-4,4'-butylidenebis(2-tertiary butyl-5-methylphenol) diphosphite, hexa(tridecyl)-1,1,3-tris(2-methyl-5-tertiary butyl-4-hydroxyphenyl)butane-triphosphite, tetrakis(2,4-di-tertiary butylphenyl)biphenylene diphosphonite, tris(2-[(2,4,7,9-tetrakis

tertiary butyldibenzo[d,f][1,3,2]dioxaphosphin-6-yl)oxy]ethyl)amine,  
9,10-dihydro-9-oxa-10-phosphaphenanthrene-10-oxide,  
2-butyl-2-ethylpropanediol-2,4,6-tri tertiary butylphenol monophosphite,  
tetrakis(2-tertiary butyl-4-methylphenyl)biphenylene diphosponite,  
tetrakis(2,4-di-tertiary amylphenyl)biphenylene diphosponite, tetrakis(2,4-di-tertiary  
butyl-5-methylphenyl)biphenylene diphosponite, and tetrakis(2-tertiary  
butyl-4,6-dimethylphenyl)biphenylene diphosponite. These may be only one kind, or  
two or more kinds.

In the general formula (3), specific examples of the organic residue represented  
by  $R^6$  include an amino group, an imino group, an amido group, an ether group, an ester  
group, a hydroxyl group, a carboxyl group, a carbamoyl group, a cyano group, and a  
sulfide group, and specific examples of the alkyl group represented by  $R^7$  include a  
hexyl group, an octyl group, a lauryl group and a stearyl group.

Specific examples of the compound represented by the general formula (3)  
include dialkyl thiodipropionates such as dilauryl ester, dimyristyl ester, myristylstearyl  
ester, and distearyl ester of thiodipropionic acid; and  $\beta$ -alkylmercaptopropionic acid  
esters of polyol such as pentaerythritol tetra ( $\beta$ -dodecylmercaptopropionate). These  
may be only one kind, or two or more kinds.

A ratio of the specified compound X occupied in the polyether composition of  
the present invention is not particularly limited, but is preferably 0.001 to 20 parts by  
weight, more preferably 0.01 to 10 parts by weight, further preferably 0.05 to 5 parts by  
weight relative to 100 parts by weight of the polyether. When the specified compound  
X is too smaller than the aforementioned range, there is a possibility that reduction in a  
molecular weight of polyether can not be sufficiently suppressed. On the other hand,  
when the specified compound X is too more than the aforementioned range, there is a

possibility that remarkable coloration occurs in the composition and, moreover, effect of suppressing reduction in a molecular weight is not improved to such an extent that it corresponds to increase to in an amount of a specified compound X, leading to high cost of the composition.

The polyether composition of the present invention may contain a phenol-based antioxidant agent which has previously been generally used for preventing oxidation, in addition to the polyether and the specified compound X.

Examples of the phenol-based antioxidant agent include 2,6-di-tertiary butyl-p-cresol, 2,6-diphenyl-4-octadecyloxyphenol, stearyl(3,5-di-tertiary butyl-4-hydroxyphenyl)propionate, distearyl(3,5-di-tertiary butyl-4-hydroxybenzyl)phosphonate, tridecyl-3,5-di-tertiary butyl-4-hydroxybenzyl thioacetate, thiodiethylenebis[(3,5-di-tertiary butyl-4-hydroxyphenyl)propionate], 4,4'-thiobis(6-tertiary butyl-m-cresol), 2-octylthio-4,6-di(3,5-di-tertiary butyl-4-hydroxyphenoxy)-s-triazine, 2,2'-methylenebis(4-methyl-6-tertiary butylphenol), bis[3,3-bis(4-hydroxy-3-tertiary butylphenyl)butyric acid]glycol ester, 4,4'-butylidenebis(2,6-di-tertiary butylphenol), 4,4'-butylidenebis(6-di-tertiary butyl-3-methylphenol), 2,2'-ethylidenebis(4,6-di-tertiary butylphenol), 1,1,3-tris(2-methyl-4-hydroxy-5-tertiary butylphenyl)butane, bis[2-tertiary butyl-4-methyl-6-(2-hydroxy-3-tertiary butyl-5-methylbenzyl)phenyl]terephthalate, 1,3,5-tris(2,6-dimethyl-3-hydroxy-4-tertiary butylbenzyl) isocyanurate, 1,3,5-tris(3,5-di-tertiary butyl-4-hydroxybenzyl) isocyanurate, 1,3,5-tris(3,5-di-tertiary butyl-4-hydroxybenzyl)-2,4,6-trimethylbenzene, 1,3,5-tris[(3,5-di-tertiary butyl-4-hydroxyphenyl)propionyloxyethyl] isocyanurate, tetrakis[methylene-3-(3',5'-di-tertiary butyl-4'-hydroxyphenyl)propionate]methane, 2-tertiary butyl-4-methyl-6-(2-acryloyloxy-3-tertiary butyl-5-methylbenzyl)phenol,

3,9-bis[2-(3-tertiary butyl-4-hydroxy-5-methylhydrocinnamoyloxy)-1,1-dimethylethyl]-2,4,8,10-tetraoxaspiro[5.5]undecane, and triethylene glycol bis[ $\beta$ -(3-tertiary butyl-4-hydroxy-5-methylphenyl)propionate]. These may be only one kind, or two or more kinds.

When the polyether composition of the present invention also contains the phenol-based antioxidant, a ratio to be contained is preferably 10 parts by weight or less relative to 100 parts by weight of the polyether. When the phenol-based antioxidant is too much, there is a tendency that remarkable coloration occurs in the composition and, moreover, there is a possibility that the cost of the composition becomes high.

The polyether composition of the present invention may appropriately contain, if necessary, further an additive such as a solvent, an aging preventing agent, a light stabilizer, a lubricant, a reinforcing agent, and a filler in such a range that the effect of the invention is not deteriorated.

#### DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

The present invention will be explained more specifically below by way of Examples and Comparative Examples, but the present invention is not limited by them. Hereinafter, unless otherwise indicated, "% by weight" is expressed by "%".

##### [Example 1]:

2g of an ethylene oxide/propylene oxide copolymer ("CP1000L" manufactured by SUMITOMO SEIKA CHEMICALS CO., LTD.; ethylene oxide/propylene oxide = 90/10 mole%, weight average molecular weight 1,070,000, glass transition temperature -60°C, melting point 45°C, elongation viscosity under shear rate of 350 (1/sec) 58,000Pa·s) which is polyether, 10mg of styrenated diphenylamine ("Stearer LAS" manufactured by SEIKO CHEMICAL CO., LTD.) as a specified compound X, and 40g

of toluene as a solvent were placed into a reactor, and the mixture was stirred at 22°C for 1 hour to obtain a polyether composition.

The resulting polyether composition was assessed as follows: that is, the resulting polyether composition was placed into a drier (air atmosphere) at 150°C, a weight average molecular weight (Mw) was measured after 2 hours (measuring apparatus: "LC-10AD" manufactured by Shimadzu Corporation, eluent: dimethylformamide solution containing 0.1% by weight of lithium bromide, standard polystyrene), and a molecular weight retaining rate relative to an initial weight average molecular weight (Mw<sub>0</sub>:1,070,000) of the used ethylene oxide/propylene oxide copolymer was calculated by the following equation. The results are shown in Table 1.

$$\text{Molecular weight retaining rate (\%)} = (\text{Mw}/\text{Mw}_0) \times 100$$

[Examples 2 to 4, and Comparative Example 1]:

According to the same manner as that of Example 1 except that an amount shown in Table 1 of a compound shown in Table 1 was used in place of the specified compound X used in Example 1, a polyether composition was obtained.

The resulting polyether composition was assessed as in Example 1. The results are shown in Table 1.

In Table 1, following abbreviations were used:

Stearer: styrenated diphenylamine ("Stearer LAS" manufactured by SEIKO CHEMICAL CO., LTD.)

PEP: bis(2,4-di-tertiary butylphenyl) pentaerythritol diphosphite ("PEP-24Q" manufactured by Asahi Denka Co., Ltd.)

TPS: dilauryl thiodipropionate ("SumilizerTPS" manufactured by Sumitomo Chemical Co., Ltd.)

Table 1

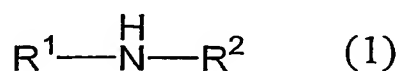
	Specified compound X		Molecular weight retaining rate (%)
	Kind	Amount (mg)	
Example 1	Stearer	10	81.4
Example 2	Phenothiazine	10	82.0
Example 3	Stearer/PEP	5/5	76.6
Example 4	Stearer/TPS	5/5	72.0
Comparative Example 1	None	0	49.1

## INDUSTRIAL APPLICATION

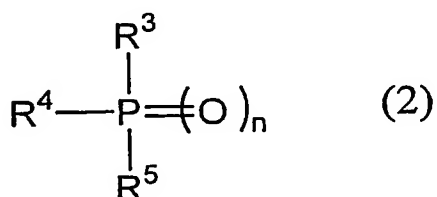
The polyether composition of the present invention is suitably used as an extrusion molding material, an antistatic agent, a polymer electrolyte, or a protecting membrane for a color filter.

## CLAIMS

1. A polyether composition, which comprises polyether having a glass transition temperature of  $-50^{\circ}\text{C}$  or lower and a melting point of  $55^{\circ}\text{C}$  or lower, and at least one kind selected from the group consisting of a compound represented by the following general formula (1), a compound represented by the following general formula (2) and a compound represented by the following general formula (3).



(in the formula (1),  $\text{R}^1$  and  $\text{R}^2$  are each independently an alkyl group of a carbon number of 1 to 8, an alkenyl group, an aryl group, an alkoxyl group or a substituted aryl group, and  $\text{R}^1$  and  $\text{R}^2$  may be bound to each other directly or via at least one kind element selected from C, O, S, P and N)



(in the formula (2),  $\text{R}^3$ ,  $\text{R}^4$  and  $\text{R}^5$  are each independently an alkyl group of a carbon number of 1 to 8, an alkenyl group, an aryl group, an alkoxyl group, a substituted aryl group, or an amino group,  $\text{R}^3$  and  $\text{R}^4$  may be bound to each other directly or via at least one kind element selected from C, O, S, P and N, and  $n$  is 0 or 1)





(In the formula (3),  $R^6$  is an organic residue, and  $R^7$  is an alkyl group of a carbon number of 1 to 30)

2. The polyether composition according to claim 1, wherein the polyether has an elongation viscosity under a shear rate of 100 to 500 (1/sec) of 100 to 1,000,000Pa·s.

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## INTERNATIONAL SEARCH REPORT

International application No.

PCT/JP2005/004404

## A. CLASSIFICATION OF SUBJECT MATTER

Int.Cl.<sup>7</sup> C08L71/02, C08K5/00

According to International Patent Classification (IPC) or to both national classification and IPC

## B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

Int.Cl.<sup>7</sup> C08L71/02, C08K5/00

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Published examined utility model applications of Japan 1922-1996  
 Published unexamined utility model applications of Japan 1971-2005  
 Registered utility model specifications of Japan 1996-2005  
 Published registered utility model applications of Japan 1994-2005

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

## C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	JP 2003-342464 A (SUMITOMO SEIKA CHEM CO LTD) 03.12.2003, see claim 1-5, [0009] ~ [0017]	1, 2
X	JP 08-503992 A (UNIROYAL CHEM CO INC) 30.04.1996, see claim 1-18	1, 2
A	JP 63-161043 A (UNIROYAL CHEM CO INC) 04.07.1988, see claim 1-25 and the full of document	1, 2
A	JP 49-128044 A (ADEKA ARGUS CHEM CO LTD) 07.12.1974, see claim 1 and the full of document	1, 2
A	JP 54-025951 A (ADEKA ARGUS CHEM CO LTD) 02.27.1979, see claim 1 and the full of document	1, 2

☒ Further documents are listed in the continuation of Box C.☒ See patent family annex.

\* Special categories of cited documents:

"A" document defining the general state of the art which is not considered to be of particular relevance

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"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone

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"&amp;" document member of the same patent family

Date of the actual completion of the international search

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Name and mailing address of the ISA/JP

Japan Patent Office

3-4-3, Kasumigaseki, Chiyoda-ku, Tokyo 100-8915, Japan

Authorized officer

Shinji Matsuura

Telephone No. +81-3-3581-1101 Ext. 3457

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## INTERNATIONALSEARCHREPORT

International application No.

PCT/JP2005/004404

C (Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	JP 56-152863 A ( ADEKA ARGUS CHEM CO LTD ) 26.11.1981, see claim 1 and the full of document	1, 2

INTERNATIONAL SEARCH REPORT  
Information on patent family members

International application No.

PCT/JP2005/004404

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		WO 94/21722 A1	29.09.1994
		EP 691997 A1	17.01.1996
JP 63-161043 A	04.07.1988	EP 274200 B1	02.02.1994
JP 49-128044 A	07.12.1974	None	
JP 54-025951 A	02.27.1979	None	
JP 56-152863 A	26.11.1981	EP 38876 B	10.10.1984

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